74CBTLV3126

4-bit bus switch
Rev. 01 — 5 January 2010

Product data sheet

General description 1.

The 74CBTLV3126 provides a 4-bit high-speed bus switch with separate output enable inputs (10E to 40E). The low on-state resistance of the switch allows connections to be made with minimal propagation delay. The switch is disabled (high-impedance OFF-state) when the output enable (nOE) input is LOW.

To ensure the high-impedance OFF-state during power-up or power-down, nOE should be tied to the GND through a pull-down resistor. The minimum value of the resistor is determined by the current-sinking capability of the driver.

Schmitt trigger action at control input makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 2.3 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Features 2.

- Supply voltage range from 2.3 V to 3.6 V
- Standard '126'-type pinout
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-5 (2.3 V to 2.7 V)
 - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - ◆ CDM AEC-Q100-011 revision B exceeds 1000 V
- \blacksquare 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

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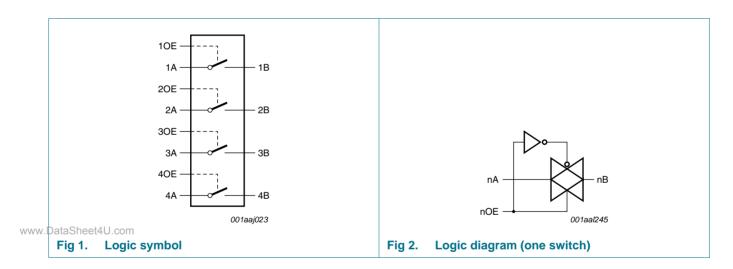
3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74CBTLV3126DS	–40 °C to +125 °C	SSOP16[1]	plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT519-1
74CBTLV3126PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74CBTLV3126BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 \times 3 \times 0.85 mm	SOT762-1

^[1] Also known as QSOP16.

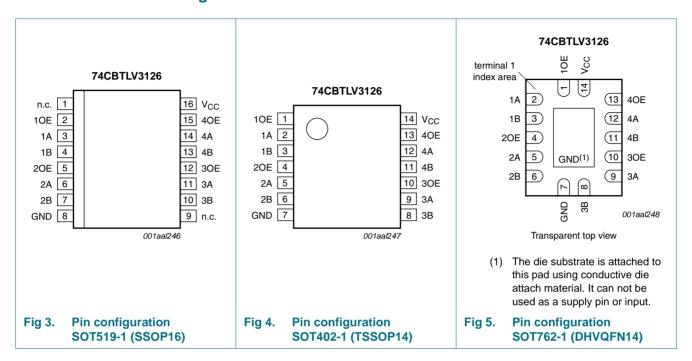
4. Functional diagram



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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin		Description
	SOT402-1 and SOT762-1	SOT519-1	
10E to 40E	^{com} 1, 4, 10, 13	2, 5, 12, 15	output enable input
1A to 4A,	2, 5, 9, 12	3, 6, 11, 14	A input/output
1B to 4B	3, 6, 8, 11	4, 7, 10, 13	B output/input
GND	7	8	ground (0 V)
V _{CC}	14	16	positive supply voltage
n.c.	-	1, 9	not connected

6. Functional description

Table 3. Function table[1]

Output enable input OE	Function switch
L	OFF-state
Н	ON-state

[1] H = HIGH voltage level; L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
V_{I}	input voltage	control inputs	<u>[1]</u> –0.5	+4.6	V
V_{SW}	switch voltage	enable and disable mode	<u>[2]</u> −0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±50	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I_{GND}	ground current		-100	-	mA
T_{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	<u>[3]</u> _	500	mW

^[1] The minimum input voltage rating may be exceeded if the input clamping current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

	Symbol	Parameter	Conditions	Min	Max	Unit
	V_{CC}	supply voltage		2.3	3.6	V
	V_{I}	input voltage	control inputs	0	3.6	V
VWW.	D v taSheet4U.co	switch voltage	enable and disable mode	0	V_{CC}	V
	T _{amb}	ambient temperature		-40	+125	°C
	Δt/ΔV	input transition rise and fall rate	pin nOE; $V_{CC} = 2.3 \text{ V}$ to 3.6 V	0	200	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to -	+85 °C	$T_{amb} = -40$ °	C to +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH} HIGH-level input voltage		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		V _{CC} = 3.0 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL} LOW-level input		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V
	voltage	V _{CC} = 3.0 V to 3.6 V	-	-	0.9	-	0.9	V
II	input leakage current	pin nOE; V_I = GND to V_{CC} ; V_{CC} = 3.6 V	-	-	±1.0	-	±20	μΑ
I _{S(OFF)}	OFF-state leakage current	V _{CC} = 3.6 V; see <u>Figure 6</u>	-	-	±1	-	±20	μΑ

^[2] The switch voltage ratings may be exceeded if switch clamping current ratings are observed

^[3] For SSOP16 and TSSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C. For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

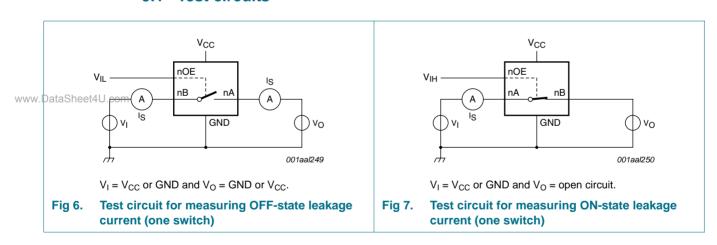
Table 6. Static characteristics ...continued

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		amb = -	-40 °C to -	-85 °C	T _{amb} = -40 °	C to +125 °C	Unit
				Viin	Typ[1]	Max	Min	Max	
I _{S(ON)}	ON-state leakage current	$V_{CC} = 3.6 \text{ V}$; see Figure 7		-	-	±1	-	±20	μΑ
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_O = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$		-	-	±10	-	±50	μΑ
I _{CC}	supply current	V_I = GND or V_{CC} ; I_O = 0 A; V_{SW} = GND or V_{CC} ; V_{CC} = 3.6 V		-	-	10	-	50	μΑ
ΔI_{CC}	additional supply current	pin nOE; $V_I = V_{CC} - 0.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$; $V_{CC} = 3.6 \text{ V}$	[2]	-	-	300	-	2000	μΑ
Cı	input capacitance	pin nOE; $V_{CC} = 3.3 \text{ V}$; $V_{I} = 0 \text{ V to } 3.3 \text{ V}$		-	0.9	-	-	-	pF
C _{S(OFF)}	OFF-state capacitance	$V_{CC} = 3.3 \text{ V}; V_{I} = 0 \text{ V to } 3.3 \text{ V}$		-	5.2	-	-	-	pF
C _{S(ON)}	ON-state capacitance	$V_{CC} = 3.3 \text{ V}; V_{I} = 0 \text{ V to } 3.3 \text{ V}$		-	14.3	-	-	-	pF

^[1] All typical values are measured at T_{amb} = 25 °C.

9.1 Test circuits



^[2] One input at 3 V, other inputs at V_{CC} or GND.

9.2 ON resistance

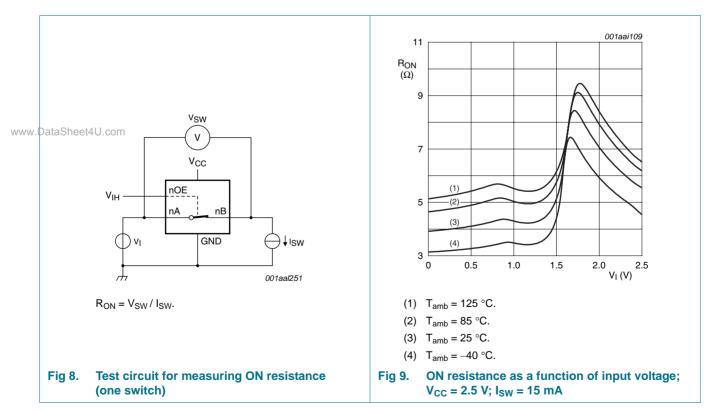
Table 7. Resistance Ron

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

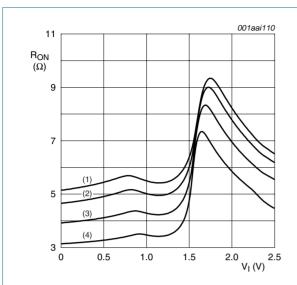
Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	T _{amb} = -40 °	C to +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V};$ see <u>Figure 9</u> to <u>Figure 11</u>						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 15 \text{ mA}; V_I = 1.7 \text{ V}$	-	8.4	40.0	-	60.0	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ see <u>Figure 12</u> to <u>Figure 14</u>						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 15 \text{ mA}; V_I = 2.4 \text{ V}$	-	6.2	15.0	-	25.5	Ω

^[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC} .

9.3 ON resistance test circuit and graphs

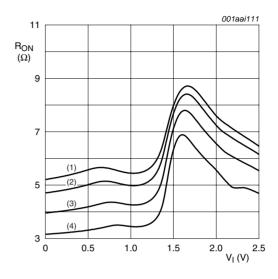


^[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.



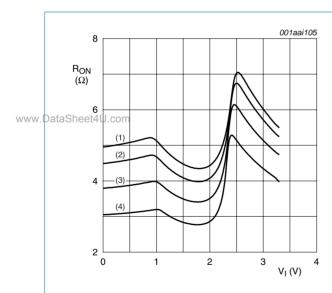
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 10. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}; I_{SW} = 24 \text{ mA}$



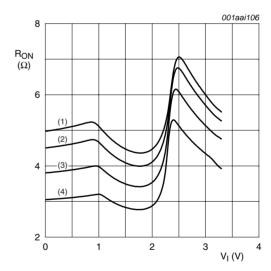
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 11. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}; I_{SW} = 64 \text{ mA}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

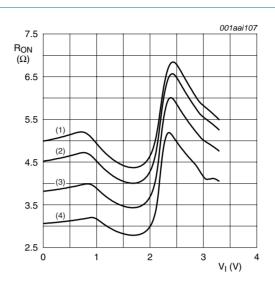
Fig 12. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}; I_{SW} = 15 \text{ mA}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 13. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}; I_{SW} = 24 \text{ mA}$

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- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 14. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}$; $I_{SW} = 64 \text{ mA}$

10. Dynamic characteristics

Table 8. Dynamic characteristics GND = 0 V; for test circuit see Figure 17

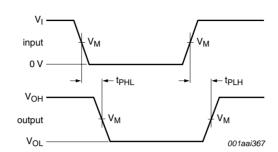
Symbol	Parameter	Conditions		T _{amb} = -	-40 °C to	+85 °C	T _{amb} = -40 °	C to +125 °C	Unit
						Max	Min	Max	
tataSheet4l propa	propagation delay	nA to nB or nB to nA; see Figure 15	[2][3]		'				'
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.13	-	0.20	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.20	-	0.31	ns
t _{en}	enable time	nOE to nA or nB; see Figure 16	<u>[4]</u>						
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.5	4.5	1.0	6.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.2	4.2	1.0	6.0	ns
t _{dis}	disable time	nOE to nA or nB; see Figure 16	<u>[5]</u>						
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.6	4.7	1.0	6.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.4	4.8	1.0	6.5	ns

^[1] All typical values are measured at T_{amb} = 25 °C and at nominal V_{CC} .

- [3] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [4] t_{en} is the same as t_{PZH} and t_{PZL} .
- [5] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

^[2] The propagation delay is the calculated RC time constant of the maximum on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

11. Waveforms



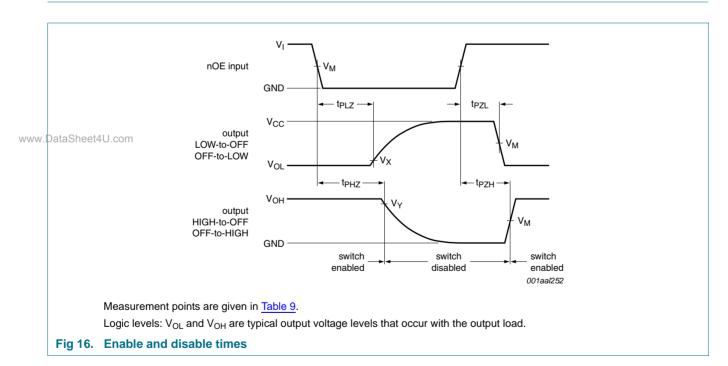
Measurement points are given in Table 9.

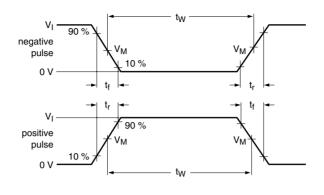
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

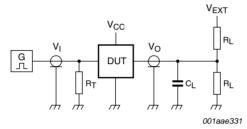
Fig 15. The data input (nA or nB) to output (nB or nA) propagation delays

Table 9. Measurement points

Supply voltage	Input			Output					
V _{CC}	V_{M} V_{I} $t_{r} =$		$t_r = t_f$	V _M	V _X	V _Y			
2.3 V to 2.7 V	0.5V _{CC}	V _{CC}	≤ 2.0 ns	0.5V _{CC}	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$			
3.0 V to 3.6 V	0.5V _{CC}	V _{CC}	≤ 2.0 ns	0.5V _{CC}	$V_{OL} + 0.3 V$	V _{OH} – 0.3 V			







Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 17. Test circuit for measuring switching times

Table 10. Test data

WW.	Supply-voltage	Load		V _{EXT}				
	V _{CC}	CL	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}		
	2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V _{CC}		
	3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V _{CC}		

12. Package outline

SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm SOT519-1

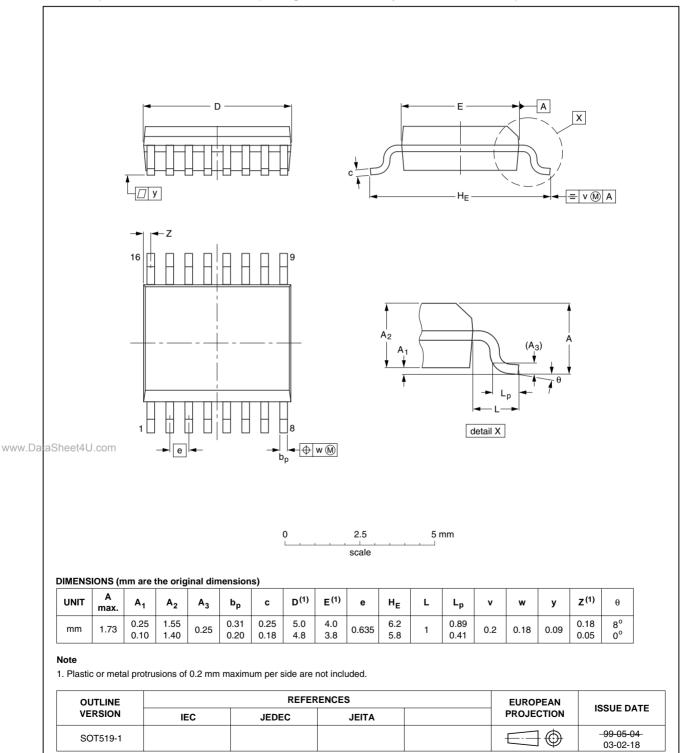
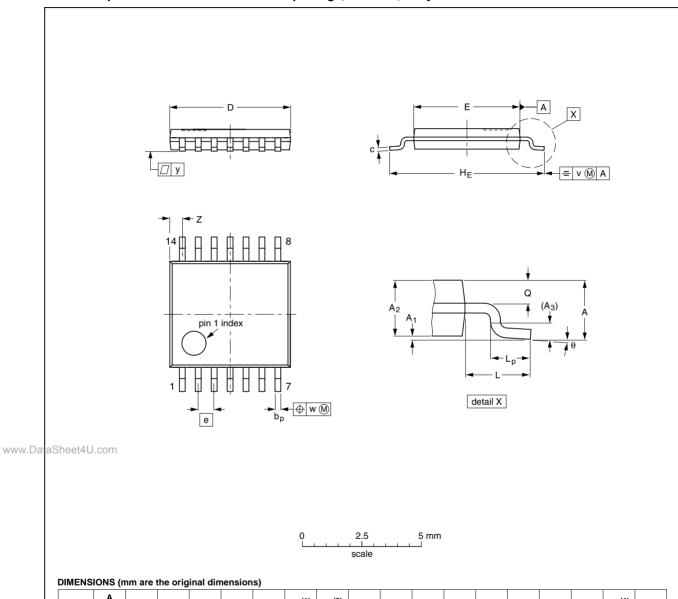


Fig 18. Package outline SOT519-1 (SSOP16)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	e	HE	L	Lp	ø	٧	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
,		IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT402-1		MO-153				99-12-27 03-02-18

Fig 19. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

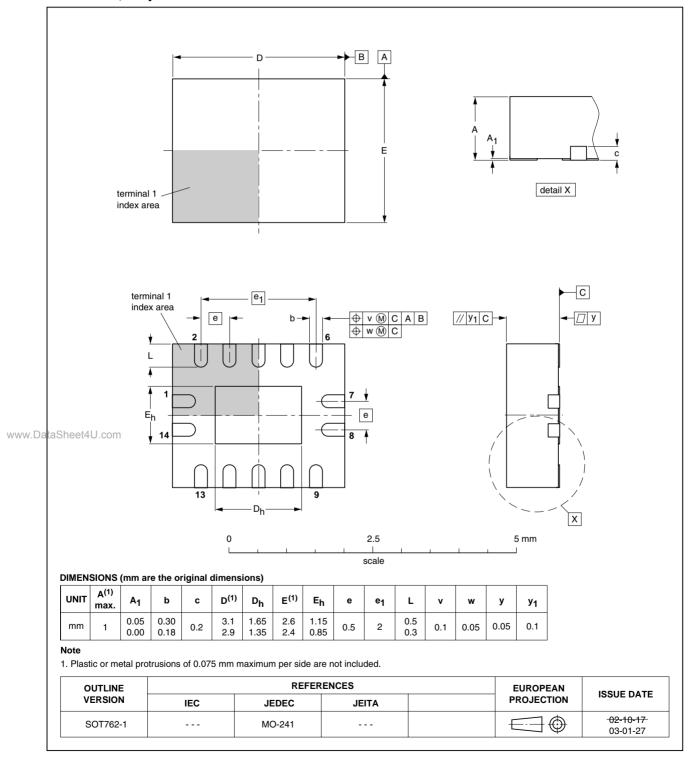


Fig 20. Package outline SOT762-1 (DHVQFN14)



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13. Abbreviations

Table 11. Abbreviations

Acronym	Description	
CDM	Charged Device Model	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MM	Machine Model	

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74CBTLV3126_1	20100105	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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